

D1FE60

**General Rectifying Diodes
600V, 1.0A**

Feature

- Small SMD
- High ESD Capability
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 1F
Package (JEDEC Code): DO-214AC

**Equivalent circuit****Absolute Maximum Ratings** (unless otherwise specified : $T_I=25^\circ\text{C}$)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T_{STG}		-55 to 150	°C
Junction temperature	T_J		-55 to 150	°C
Repetitive peak reverse voltage	V_{RRM}		600	V
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, $T_I=126^\circ\text{C}$	1	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On alumina substrate, $T_a=25^\circ\text{C}$ *	1	A
Average forward current	$I_F(AV)$	50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_a=25^\circ\text{C}$ *	0.8	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive 1 cycle peak value, $T_j=25^\circ\text{C}$	30	A
Surge forward current	I_{FSM1}	$t_p=1\text{ms}$, sine wave, Non-repetitive, peak value, $T_j=25^\circ\text{C}$	70	A

* : See the original Specifications

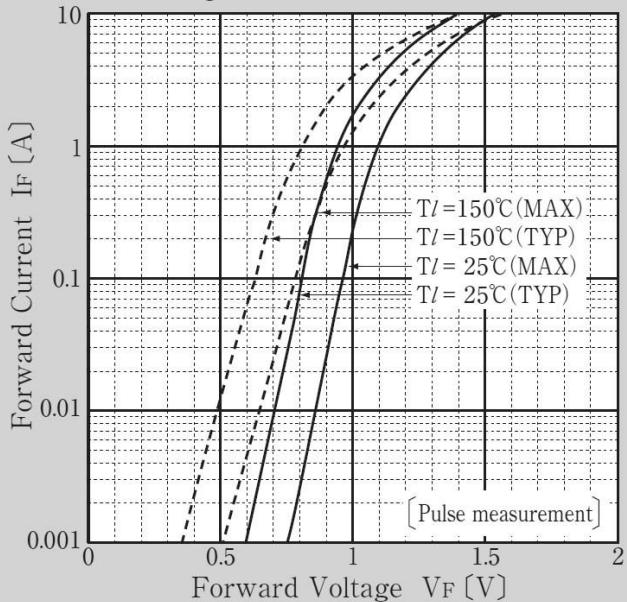
Electrical Characteristics (unless otherwise specified : T_l=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V _F	I _F =1A, Pulse measurement			1.1	V
Reverse current	I _R	V _R =600V, Pulse measurement			10	μA
Electro static discharge Capability	V _{ESD}	C=150pF, R=150Ω, Polarity±, Aerial discharge		25		kV
Thermal resistance	R _{th(j-l)}	Junction to lead			23	°C/W
Thermal resistance	R _{th(j-a)}	Junction to ambient, On alumina substrate *			108	°C/W
Thermal resistance	R _{th(j-a)}	Junction to ambient, On glass-epoxy substrate *			157	°C/W

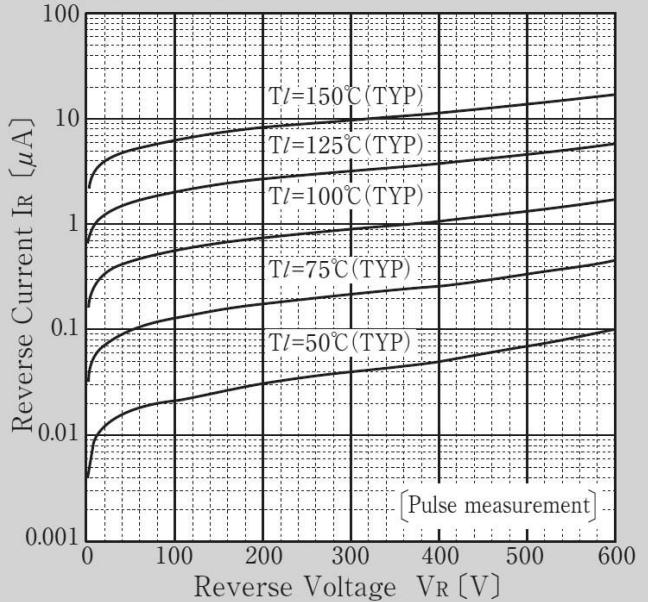
* : See the original Specifications

CHARACTERISTIC DIAGRAMS

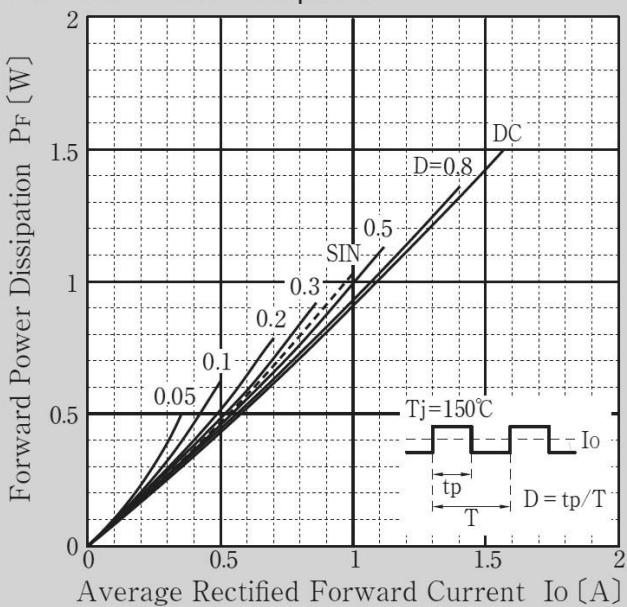
Forward Voltage



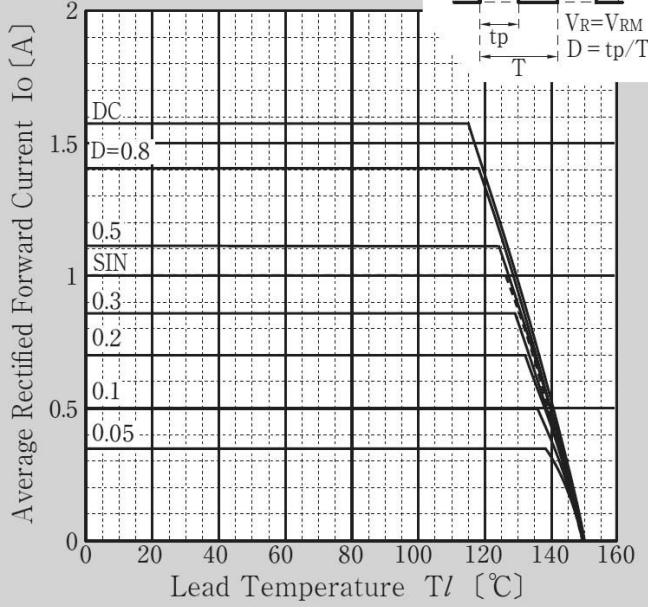
Reverse Current

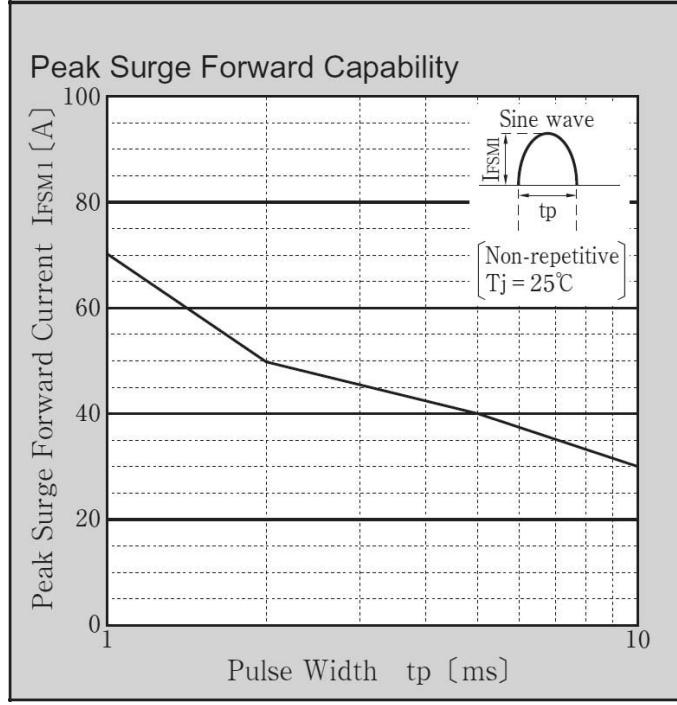
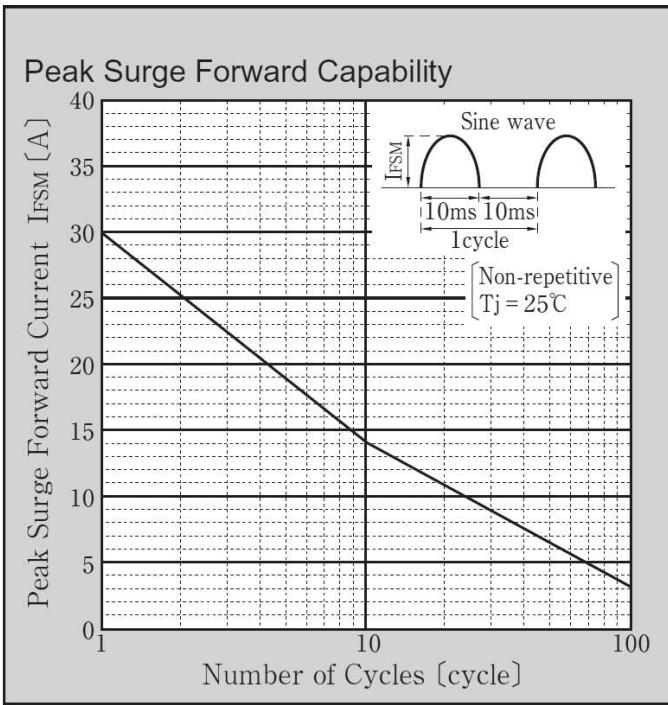
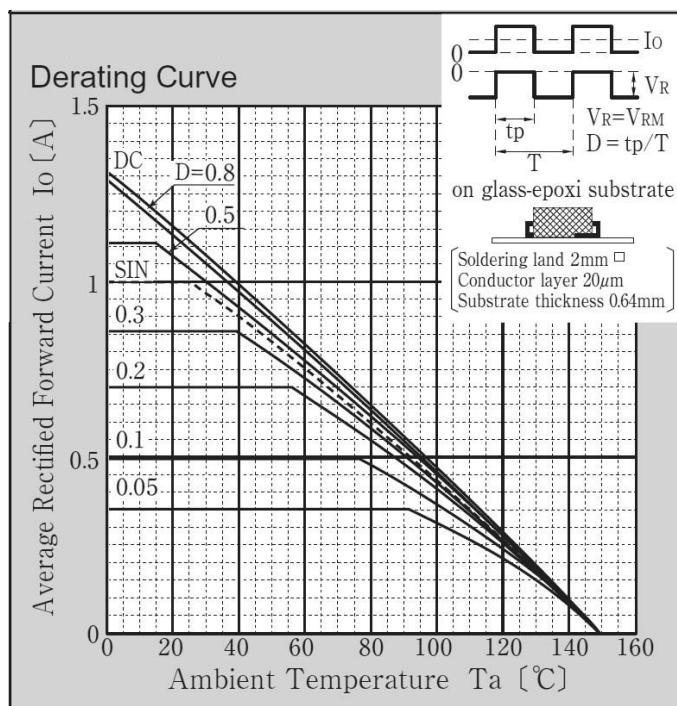
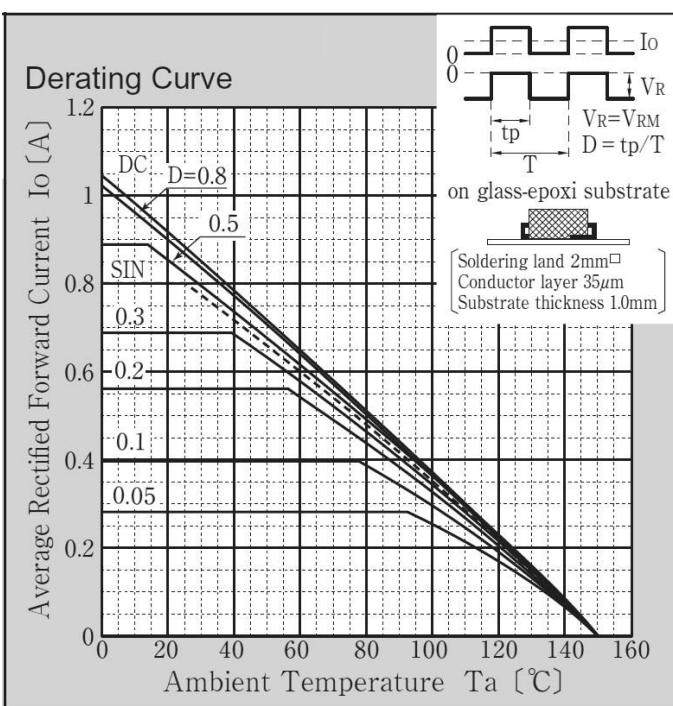


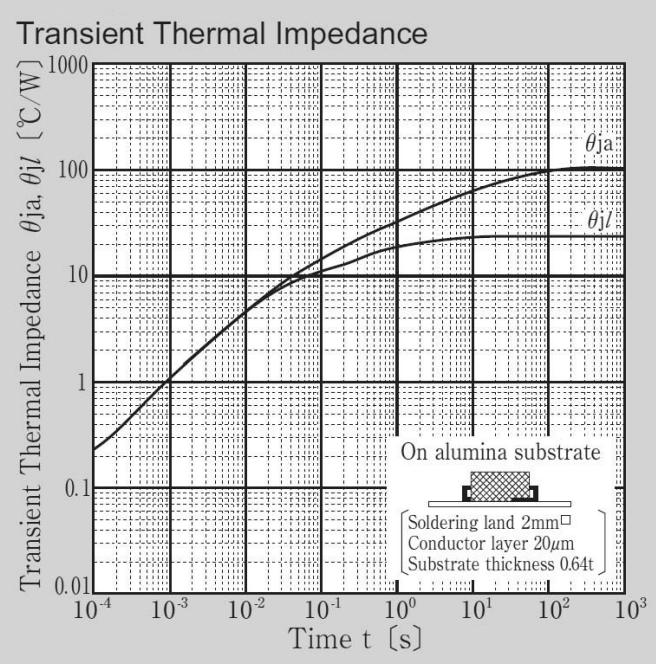
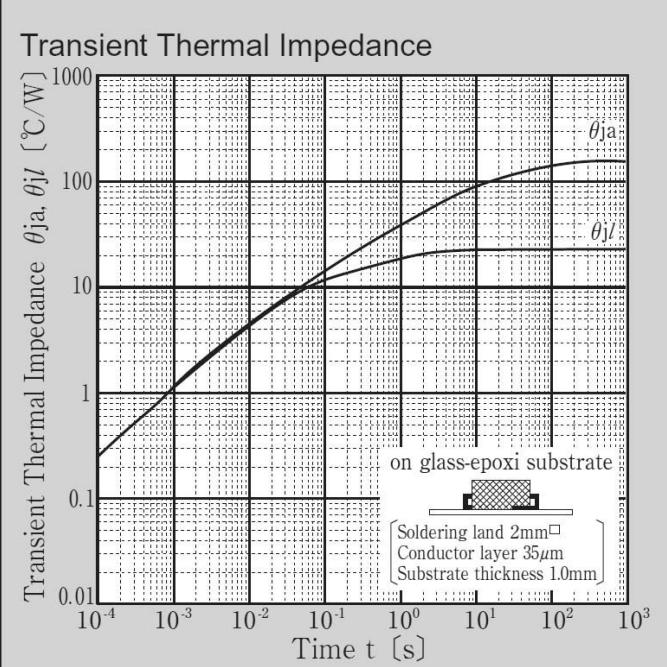
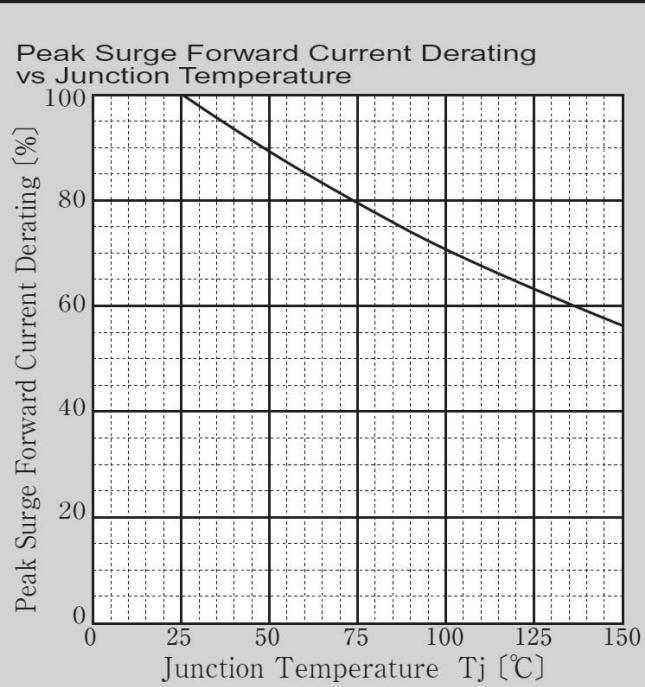
Forward Power Dissipation



Derating Curve







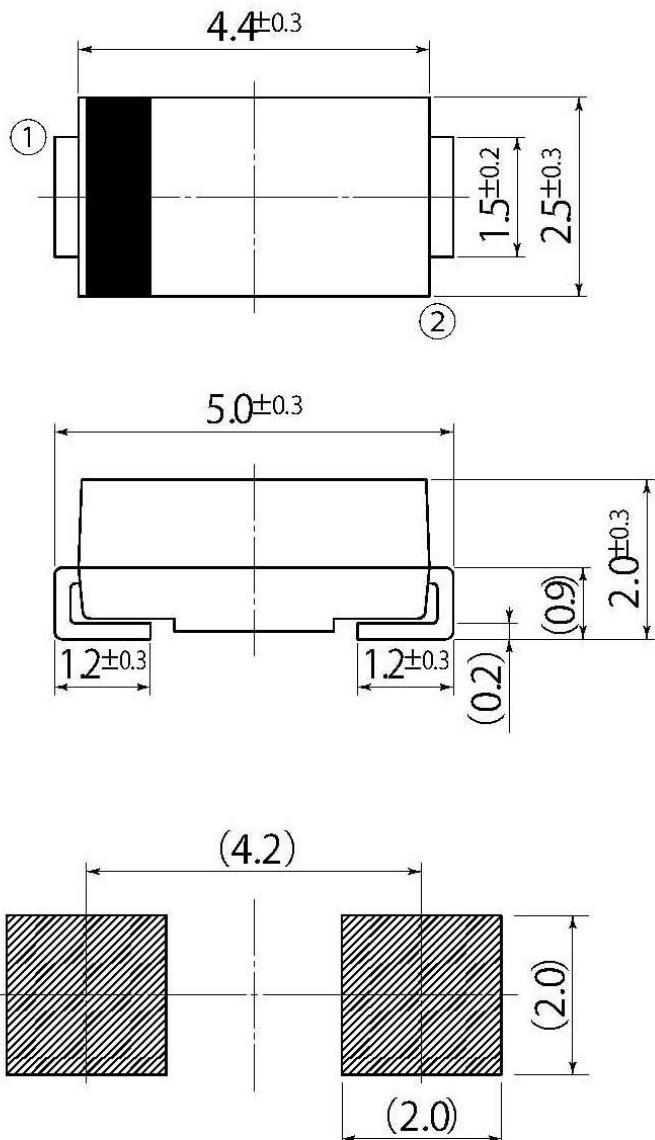
Outline Dimensions

unit:mm

scale: 10/1

B3

JEDEC Code	DO-214AC
JEITA Code	-
House Name	1F, CF



Referential Soldering Pad

- Optimize soldering pad to the board design and soldering condition.